



US00D480638S

(12) **United States Design Patent**  
**Lee**

(10) **Patent No.:** **US D480,638 S**

(45) **Date of Patent:** **\*\* Oct. 14, 2003**

(54) **BLISTER PACK**

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Eindhoven (NL)**

(\*\*) **Term:** **14 Years**

(21) **Appl. No.:** **29/178,435**

(22) **Filed:** **Mar. 26, 2003**

(30) **Foreign Application Priority Data**

Oct. 16, 2002 (WO) ..... DMA/005 855

(51) **LOC (7) Cl.** ..... **09-03**

(52) **U.S. Cl.** ..... **D9/415**

(58) **Field of Search** ..... D9/414, 415, 418,  
D9/337, 457; 206/461-471, 806, 495, 769-776,  
761-765

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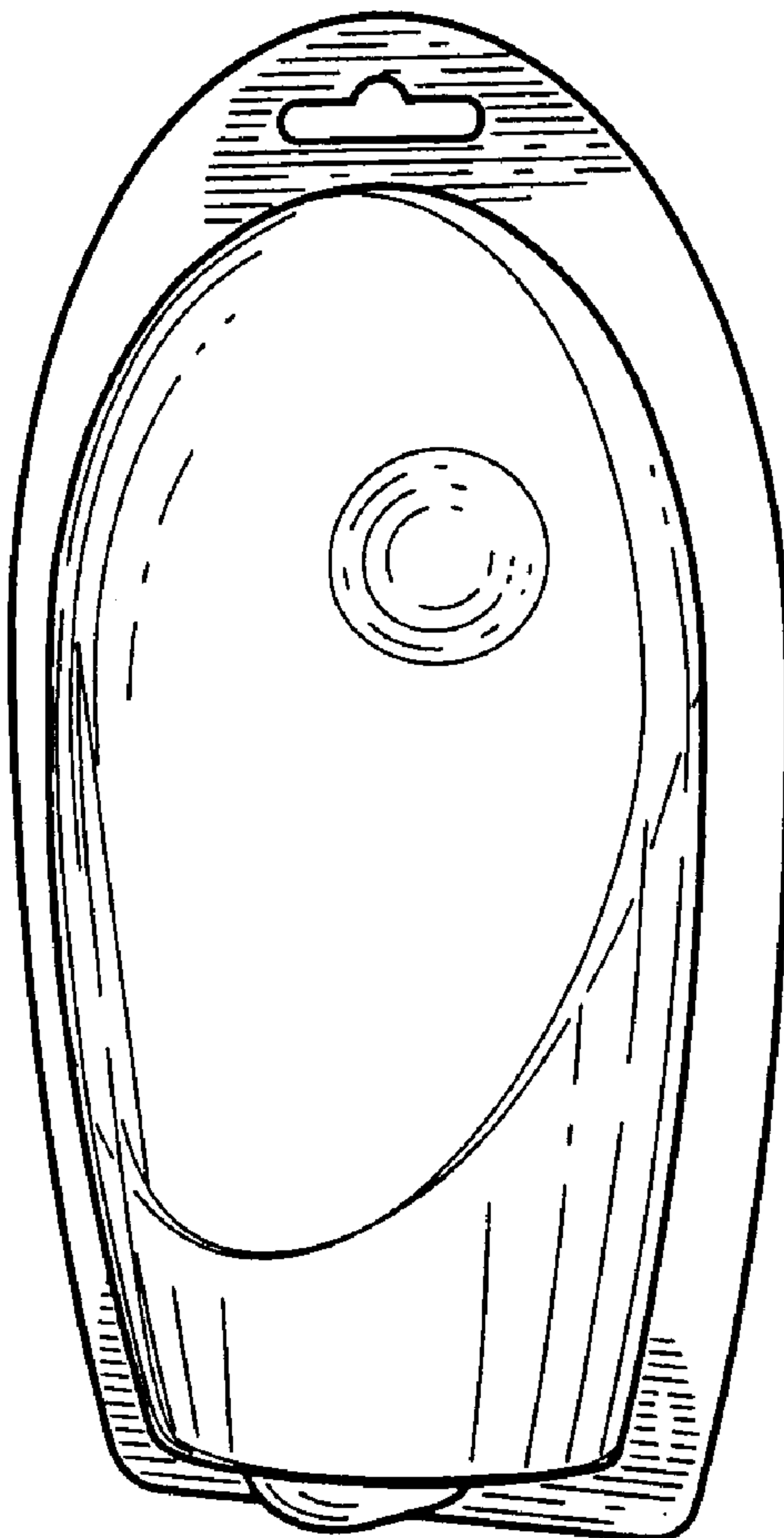
(57) **CLAIM**

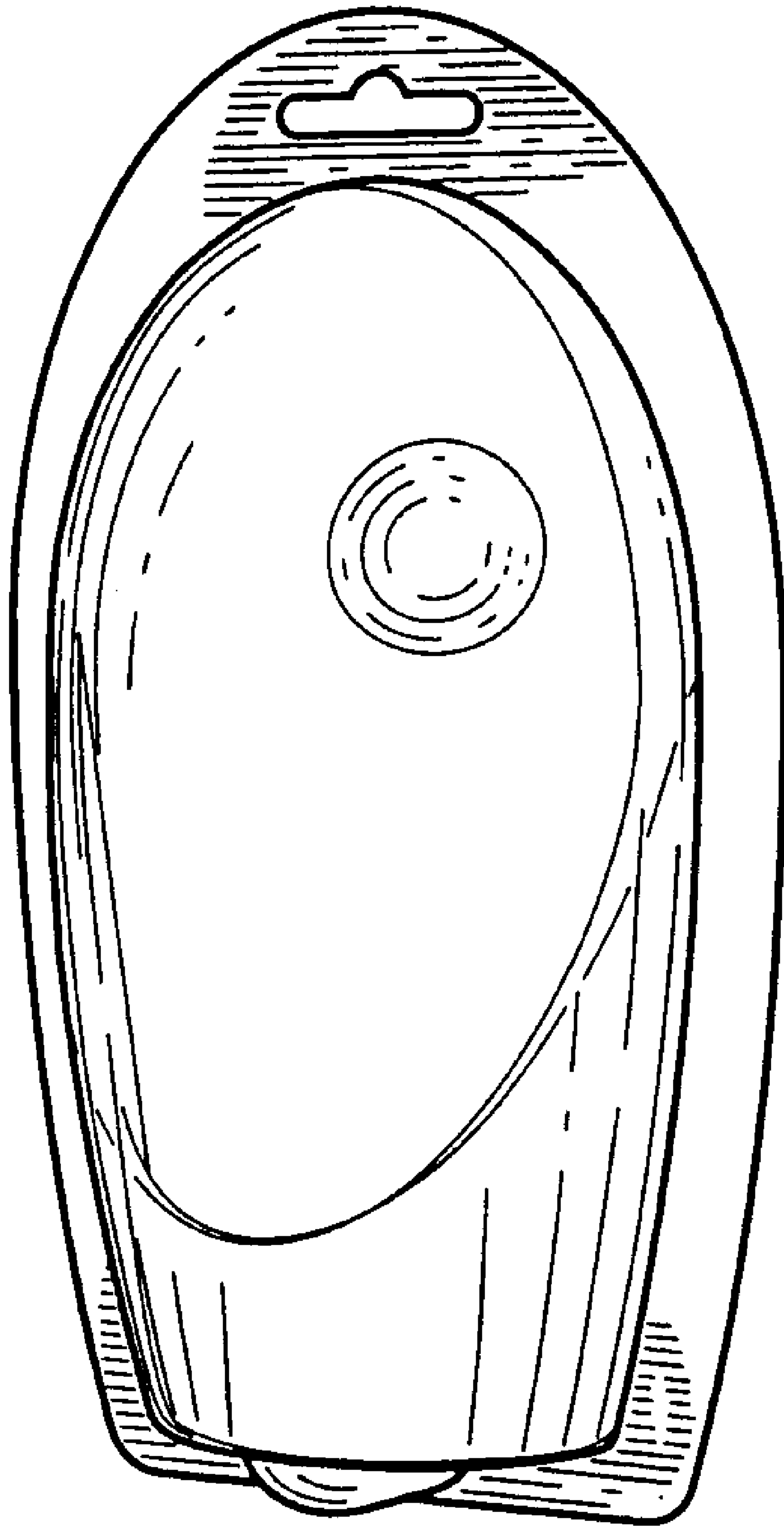
The ornamental design for a blister pack, as shown.

**DESCRIPTION**

FIG. 1 is a perspective view showing my design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a left side elevational view thereof;  
FIG. 5 is a right side elevational view thereof;  
FIG. 6 is a top plan view thereof; and,  
FIG. 7 is a bottom plan view thereof.

**1 Claim, 3 Drawing Sheets**





**FIG. 1**

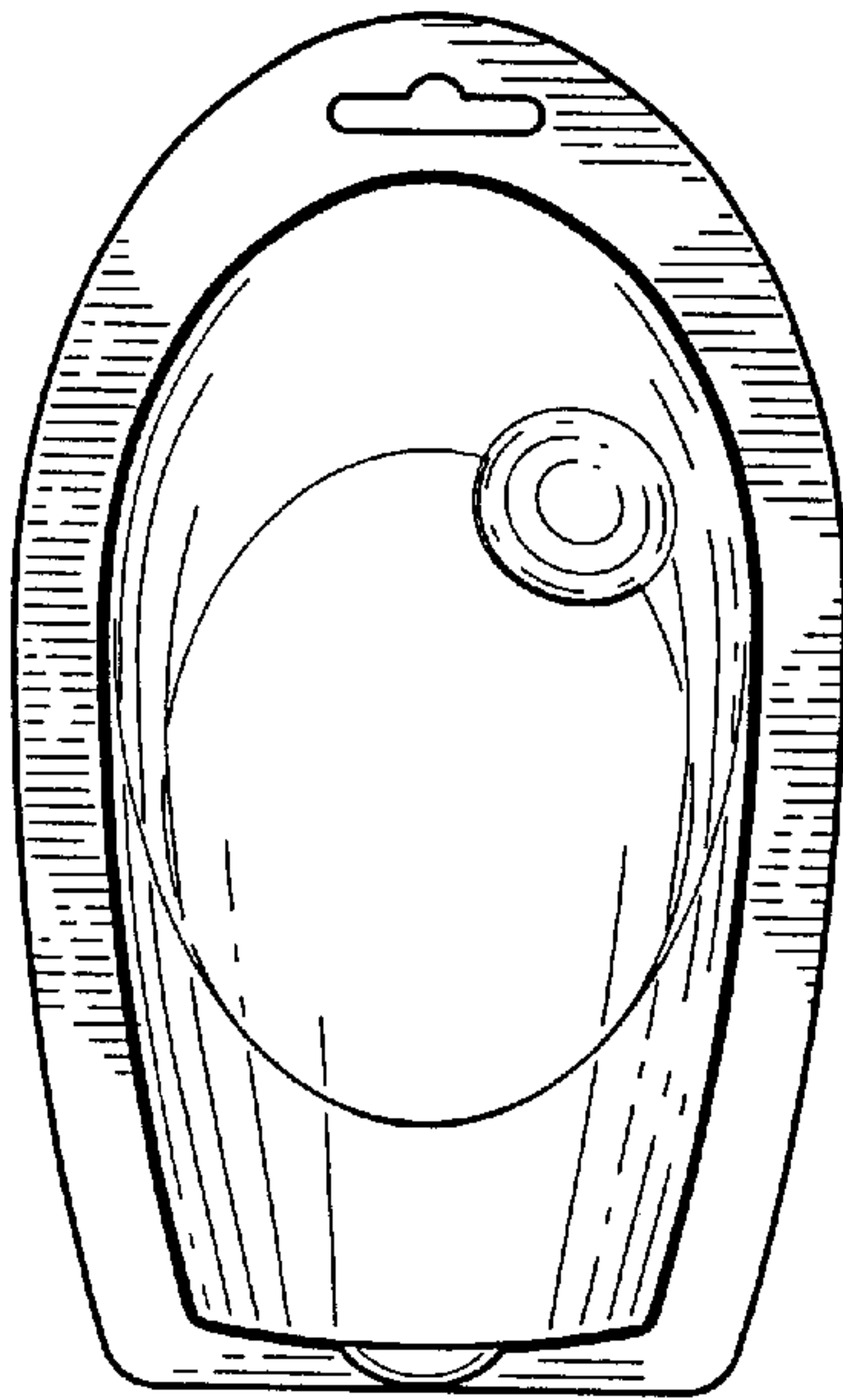


FIG. 2

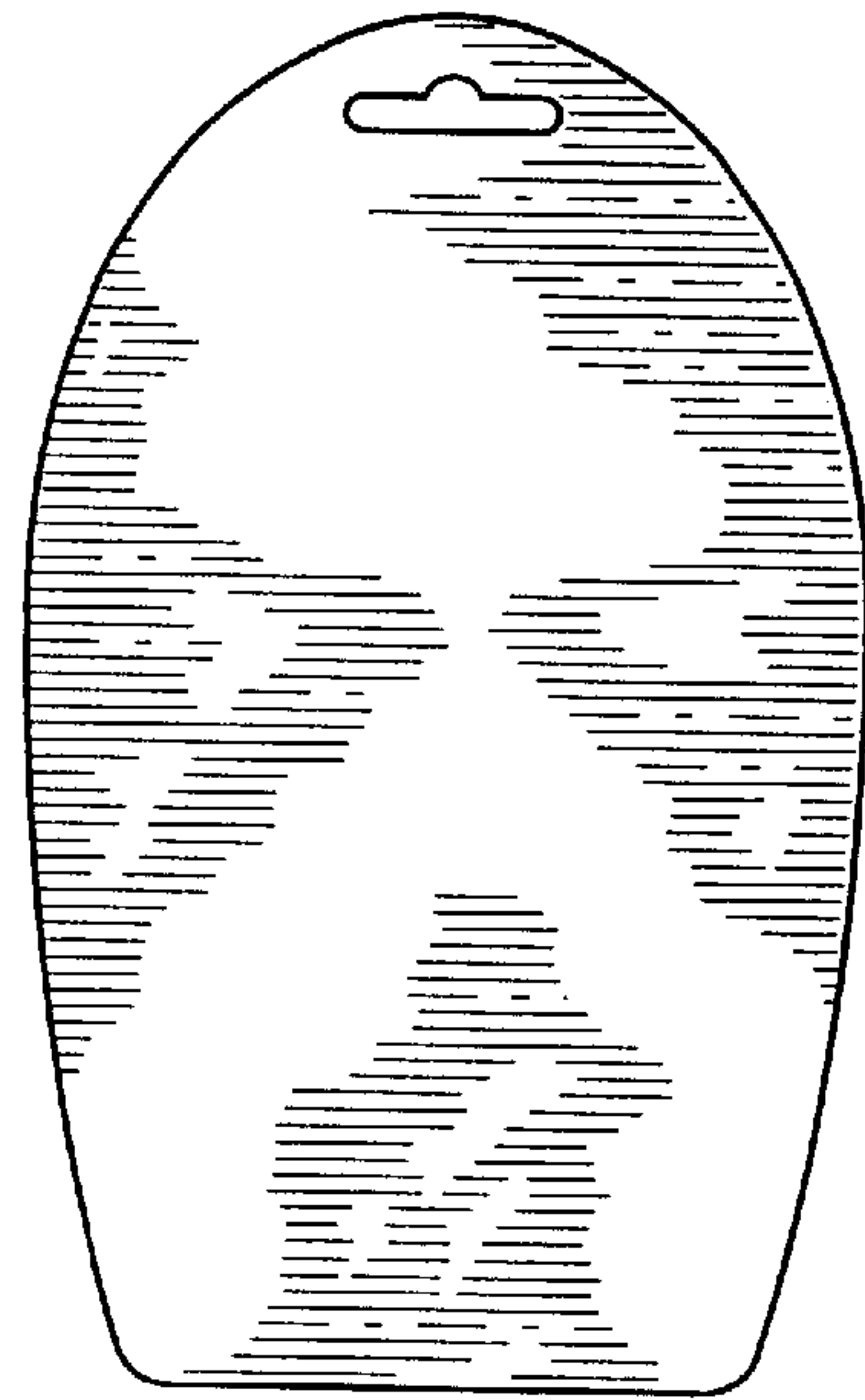


FIG. 3

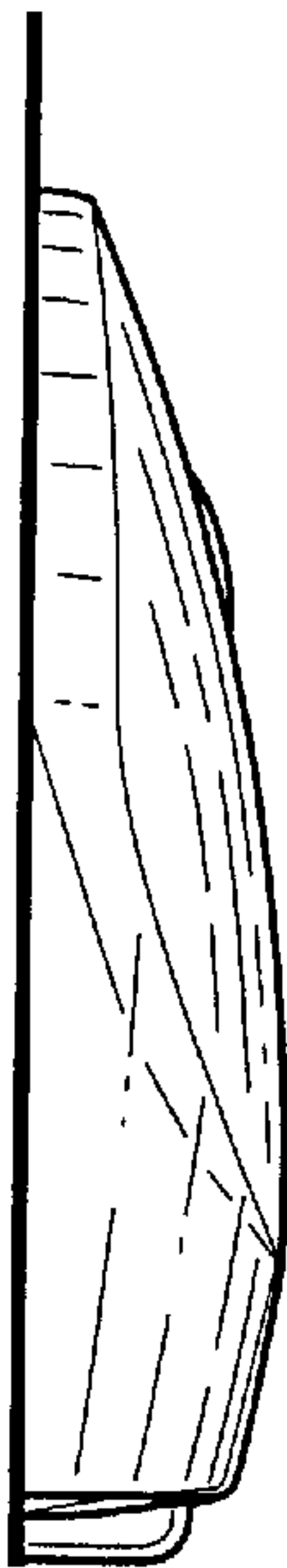


FIG. 4

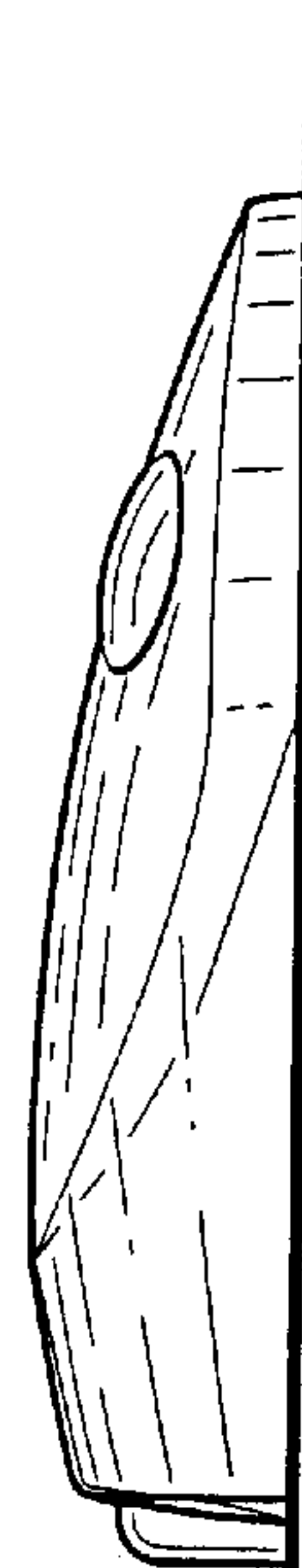


FIG. 5

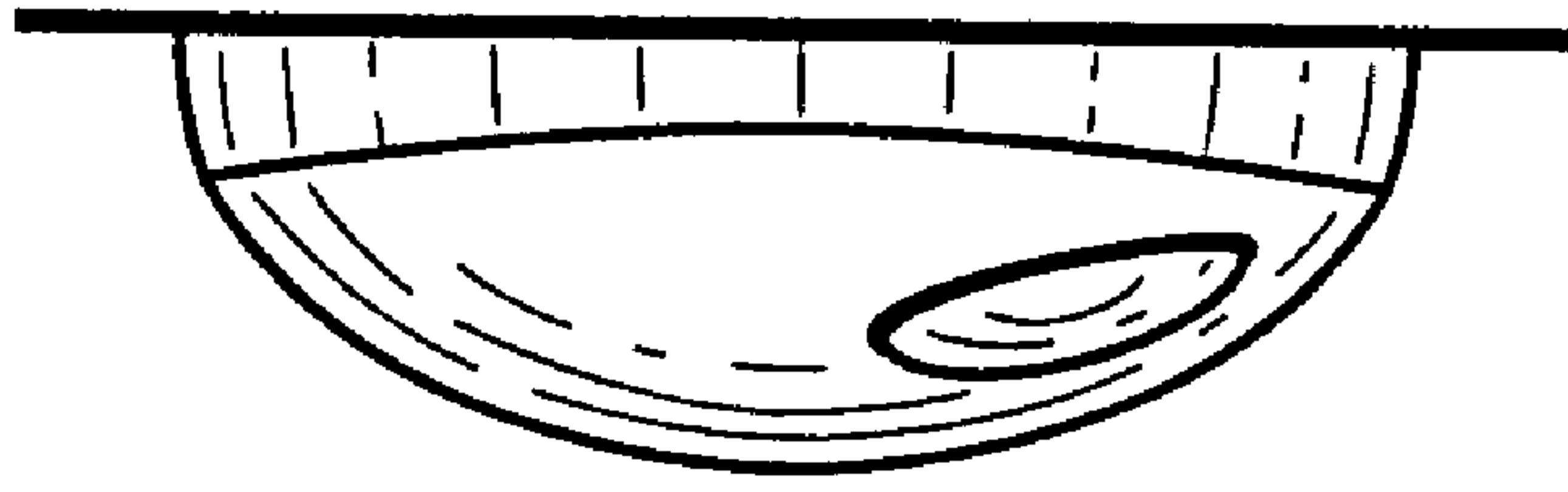


FIG. 6

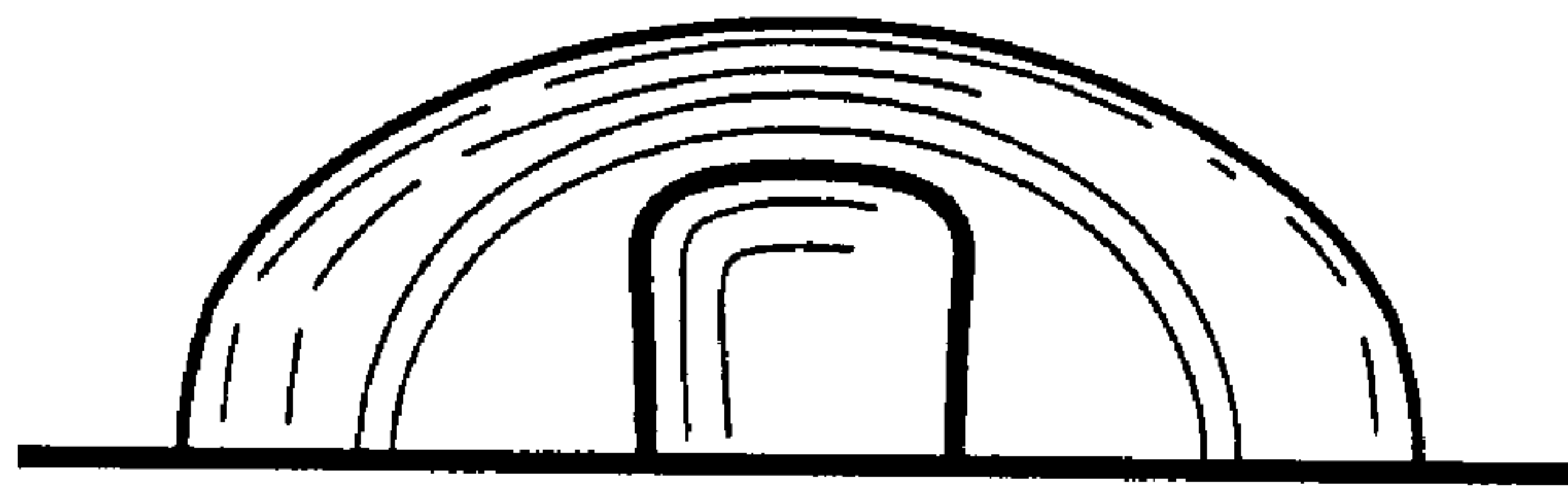


FIG. 7